The ATLAS High-Granularity Timing Detector: test beam campaigns and results

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Part 1: Introduction

HL-LHC and timing

- For HL-LHC number of simultaneous pp interactions can be up to 200 and separating pile-up from event of interest becomes more challenging
- Fining information can be utilized to reject PU, complementing the position measurement with the new ATLAS Inner tracker (ITk)



High Granularity Timing Detector (HGTD)

- F Two instrumented double-sided layers in each endcap





S Example: Using HGTD together with ITk gives improvement in forward pileup jet rejection by up to ~20% (compared to ITk only)



HGTD sensor and electronics

F HGTD must be able to provide time resolution

© 35 ps/hit (start of operation)

≈ 70 ps/hit (end of operation)

Sensor also must survive the irradiation. Low Gain Avalanche Detector (LGAD) is capable and chosen as sensor



- % Sensors will be (partially) replaced several times after $2.5 \mathrm{x} 10^{15} \, \mathrm{n_{eq}/cm^2}$
- Need equally fast read-out electronics: use ALTIROC
- ℜ Will have ~8000 LGAD+ASIC modules in HGTD



LGAD

- § Sensor must be thin to minimize landau fluctuations. But it cannot be too thin because this will drive the capacitance. Optimal thickness ~ 50 um
- IGADs are n-on-p silicon detectors with an additional p-type doped layer containing charge multiplication to achieve an internal gain
- \Re Gain must be low because otherwise noise grows

$$\sigma_j = \frac{\sigma_n}{\left|\frac{dV}{dt}\right|} \approx \frac{\sigma_n}{\left|\frac{S}{\tau_p}\right|} = \frac{\tau_p}{S_{/N}}$$

- Current version of LGAD is carbon enriched since it allows to use lower operating voltage, which allows to avoid Single Event Burnout: sensor break with starshaped pattern formed.
- This version of sensor performs as required after irradiation

arXiv: 2303.07728



JINST, 17(07):C07020, 2022. https://arxiv.org/abs/2306.12269

HGTD sensors replacement scheme

 $\$ The closer to the beam the higher the fluence

Sensors only able to survive outer layer fluence therefore

inner ring sensors replaced every 1000 fb-1 (3 times)
middle ring sensors replaced at 2000 fb-1 (once)
Outer ring never replaced (42% of HGTD)





ALTIROC

- ALTIROC1 is small-scale 25 (5x5) channel prototype with all analog functionality
- ALTIROC2 is a full-scale prototype with 225 (15x15) channels

Should be close to final version

Feach ALTIROC channel will provide a TOA and TOT measurements of the LGAD signal for a given threshold.



Structure repeated each ASIC channel



Testbeam setup at CERN SPS H6



Part 2: ALTIROC1+sensor module tests

More in paper: <u>2023 JINST 18 P08019</u> / <u>arxiv:2306.08949</u> ALTIROC1+LGAD tested at room temperature. Two SiPMs are needed in order to solve for module time resolution (LGADs mounted on custom readout boards were tested in parallel)













TOT-TOA coupling caveat

- FOA-TOT is expected to be flat but it's not. This is attributed to a digital coupling synchronized with the 40 MHz clock.
- $\$ This degrades timing performance
- Since we record pulses from preamplifier probe can see why TOT depends on TOA from average pulses





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Timewalk

- Finewalk is one of the effects degrading the time resolution
- \Im It can be mitigated if signal amplitude is known
- In ALTIROC prototypes have: probe amplitude (debug feature), TOT,...
- \Re Example of probe timewalk for Δ_t (module,SiPM1)







Record amplitude at this point





Part 3: ALTIROC2+sensor module tests

- ALTIROC2 testbeam setup is similar to ALTIROC1 except that instead of two reference SiPMs, a single MCP-PMT was used
- MCP-PMT resolution is negligible when combined in quadrature with module(~40ps) and compared to SiPMs that were used for ALTIROC1 testbeam (~50ps at best)
- Solve the 3x3 equation system, instead do

 $\Delta t = -\text{TOA*LSB} - (t_{\text{MCP}} - t_{\text{clock}})$

𝔅 Where

- MCP is a reference device, time when it's fired taken wrt to clock because asicTOA is measured wrt to clock
- asicTOA is *LSB in order to convert from binary to ps





ALTIROC2+LGAD+test board

- Room temperature
- ~half of ASIC pixels activated
- Sensor bias voltage is -180 V corresponding to a charge of ~20 fC
- The EUDET telescope is used for track reconstruction
- Standalone reconstruction software used
- Fificiency map measured as ratio of the reconstructed tracks with a hit seen in ALTIROC to all the reconstructed tracks penetrating the sensor area
- \$ 100% hit efficiency demonstrated for full-size module

ATLAS HGTD Test Beam Preliminary



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Efficiency

0.8

Module interpad size from (In)Eff between the pixels

- S Zoom into each vertical, horizontal gap
- Fake 50 % width as definition of width, get it from linear interpolation
- Sizes of gaps are reasonably uniform
- \Re Nominal is 49 μ m







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- R HGTD will be added to ATLAS for HL-LHC to mitigate pile-up via timing measurement
- Radiation tolerant LGADs testbeam performance meets the requirements: charge collected, time resolution, efficiency.
- ALTIROC1+LGAD module (small-size ATLAS HGTD ASIC prototype mounted on the sensor) demonstrated in Test Beam the capability to provide timing information with resolution 40.2 +/- 0.4 ps, which is close to the requirement. However, part of the information not available in the final chip was used. With TDC-only information, the resolution is 46 ps.
- ALTIROC2+LGAD full-size module time resolution is similar. Resolution is better near amplitude peak value, behavior coming from sensor itself and also observed in ALTIROC1.
- RALTIROC2+LGAD showed 100% hit efficiency in Test Beam, as required.
- § 50%-50% size of interpad regions is extracted from efficiency maps and equal to 65.3 +/- 0.2 μ m.
- RALTIROC3 (full-size, fully radiation hard, certain adjustments to design) is available since April, performed first testbeam two weeks ago, another one will happen in two weeks

The End

Backup \downarrow

$\$ Tracker is good enough

% https://cds.cern.ch/record/2851661/files/ATL-HGTD-SLIDE-2023-015.pdf



Radiation tolerant sensors performance arXiv: 2303.07728

- ℜ LGAD R&D is approaching the final design that should be radiation tolerant and meet the performance requirement after irradiation: <u>Q>4 fC</u>, $σ_t$ <70 ps, ε>95 %
- Before unirradiated sensors tested, now radiation tolerance is added by using <u>carbon-enriched</u> LGAD samples. Three vendors considered: FBK, IHEP-IME, USTC-IME
- Sensors were irradiated to 2.5x10¹⁵ n_{eq}/cm² and then put into DESY (electron), SPS (pion) testbeams. Carbon-enriched LGADs from three vendors meet the HGTD requirements
- \Re Tests are done with custom read-out, not the actual HGTD electronics

